

# **R433**







### 1. SCOPE

This specification is applied to a SAW resonator designed for the stabilization of transmitters such as garage door openers and security transmitters.

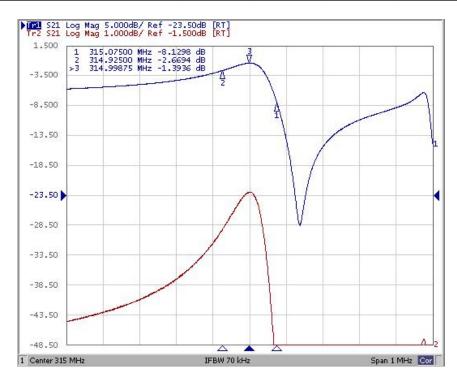
### 2. EL ECTRICAL SPECIFICATION

### 2.1 Maximum Rating

| DC Voltage VDC        | 10V            |  |  |
|-----------------------|----------------|--|--|
| AC Voltage Vpp        | 10V 50Hz/60Hz  |  |  |
| Operation temperature | -40°C to +85°C |  |  |
| Storage temperature   | -45°C to +85°C |  |  |
| Max Input Power       | 1 0 dBm        |  |  |

### 2.2 Electronic Characteristics

| Item                              |                        |              | Unites     | Minimum | Typical | Maximum |
|-----------------------------------|------------------------|--------------|------------|---------|---------|---------|
| Center Frequency                  |                        |              | MHz        | 433.845 | 433.920 | 433.995 |
| Insertion Loss                    |                        |              | dB         |         | 1.6     | 2.2     |
| Quality Factor                    |                        | Unload Q     |            | 8300    | 12000   |         |
|                                   |                        | 50Ω Loaded Q |            | 850     | 1500    |         |
| Temperature                       | Turnover Temperature   |              | $^{\circ}$ | 10      | 25      | 40      |
| Stability                         | Freq.temp.Coefficient  |              | ppm/℃      |         | 0.032   |         |
| Frequency Aging                   |                        |              | ppm/yr     |         | <±10    |         |
| DC. Insulation Resistance         |                        |              | MΩ         | 1.0     |         |         |
| RF                                | Motional Resistance R1 |              | Ω          |         | 18      | 26      |
| Equivalent                        | Motional Inductance L1 |              | μН         |         | 79.82   |         |
| RLC Model Motional Capacitance C1 |                        | fF           |            | 1.685   |         |         |
| Transducer Static Capacitance C0  |                        |              | pF         |         | 2.3     |         |





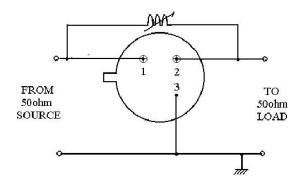
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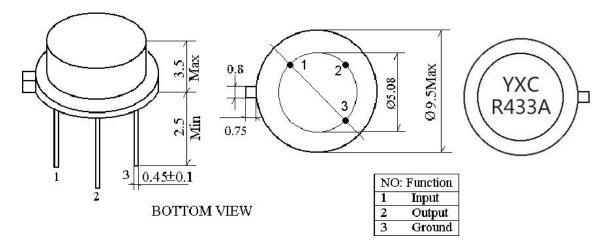


### 3. TEST CIRCUIT



R433 TO39 3Pin

### 4. DIMENSION



R433 TO39 3Pin

### 5. ENVIRONMENTAL CHARACTERISTICS

### 5-1 High temperature exposure

Subject the device to +85°C for 16 hours. Then release the resonator into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2.2.

### 5-2 Low temperature exposure

Subject the device to  $-40^{\circ}$ C for 16 hours. Then release the device into the room conditions for 24 hours prior to the measurement. It shall fulfill the specifications in 2.2.

#### 5-3 Temperature cycling

Subject the device to a low temperature of  $-40^{\circ}$ C for 30 minutes. Following by a high temperature of  $+85^{\circ}$ C for 30 Minutes. Then release the device into the room conditions for 24 hours prior to the measurement. It shall meet the specifications in 2.2.

#### 5-4 Resistance to solder heat

Dip the device terminals no closer than 1.5mm into the solder bath at  $260^{\circ}$ C  $\pm 10^{\circ}$ C for  $10\pm 1$  sec. Then release the device into the room conditions for 4 hours. The device shall meet the specifications in 2.2.



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### 5-5 Solderability

Subject the device terminals into the solder bath at  $245^{\circ}$ C  $\pm 5^{\circ}$ C for 5s, More than 95% area of the terminals must be covered with new solder. It shall meet the specifications in 2.2.

### 5-6 Mechanical shock

Drop the device randomly onto the concrete floor from the height of 1m 3 times. the device shall fulfill the specifications in 2.2.

### 5-7 Vibration

Subject the device to the vibration for 1 hour each in x, y and z axes with the amplitude of 1.5 mm at 10 to 55 Hz. The device shall fulfill the specifications in 2.2.

### 6. REMARK

### 6.1 Static voltage

Static voltage between signal load & ground may cause deterioration &destruction of the component. Please avoid static voltage.

### 6.2 Ultrasonic cleaning

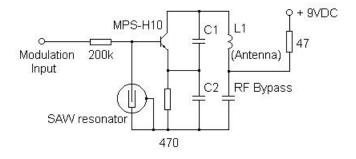
Ultrasonic vibration may cause deterioration & destruction of the component. Please avoid ultrasonic cleaning

#### 6.3 Soldering

Only leads of component may be soldered. Please avoid soldering another part of component.

### 7. TYPCIAL APPLICATION CIRCUITS

### Typical low-power Transmitter Application



### Typical Local Oscillator Application

